

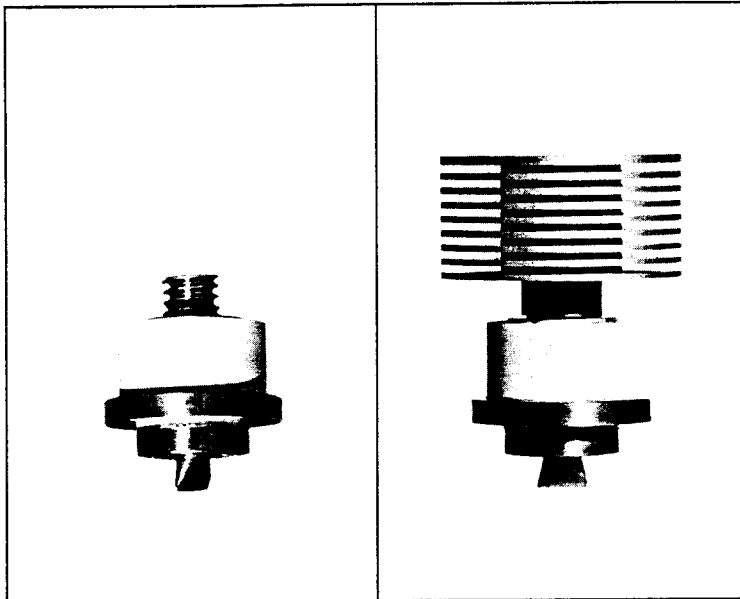
ML-8534

ML-8535



**Miniature
 UHF Planar Triodes**

CW, Plate or Grid Pulsed
 Frequency Stable
 Phormat Cathode
 High Cathode-Current Capability
 100W CW at 2.3 GHz



DESCRIPTION

The ML-8534 and ML-8535 are ruggedized, high-mu planar triodes of ceramic-and-metal construction, designed for use as grid-pulsed, plate-pulsed or CW oscillators, frequency multipliers, or amplifiers in radio transmitting service from low frequency to 3 GHz. The ML-8534 is supplied without a radiator for conduction-convection or heat-sink cooling. The ML-8535 is supplied with a radiator for forced-air cooling. Except for plate-dissipation ratings, the characteristics of the two tubes are the same.

Distinguishing characteristics of these tubes are their min-

iaturation and high cathode-current capability. In addition to low interelectrode capacitance, high transconductance and high mu, these tubes also incorporate design features which help to assure frequency-stable operation even under conditions of adverse ambient temperature and varying plate dissipation. The tubes also employ a Phormat type cathode which consists of an indirectly heated disc with an oxide coating impregnated in a nickel matrix. This construction, in combination with proper plate series impedance, reduces to a minimum failures of the cathode due to voltage surges.

Note: Data contained herein are based on initial design and test criteria. Before using these data in final equipment designs, consult Machlett for possible revisions.

GENERAL CHARACTERISTICS

Electrical

Heater Voltage (AC or DC)	6.3 V
Heater Current at 6.3 Volts	1.30 A
Cathode Heating Time, minimum	60 sec
Amplification Factor	80
Transconductance ($J_k=200\text{mA}/\text{cm}^2$)	38000 μmhos
Interelectrode Capacitance, without Heater Voltage	
Grid-Plate	2.25 pf
Grid-Cathode	9.5 pf
Plate-Cathode, maximum065 pf

Mechanical

Mounting Position	Optional
Type of Cooling	
With radiator (ML-8535)	Forced-Air
Without radiator (ML-8534)	Conduction & Convection
Maximum Anode Temperature	250 °C
Net Weight	
With radiator (ML-8535)	45 g
Without radiator (ML-8534)	20 g

**MAXIMUM RATINGS AND
TYPICAL OPERATING CONDITIONS**

**CW RF Power Oscillator and Amplifier
Class C**

Maximum Ratings, Absolute Values

DC Plate Voltage	2500	V
DC Grid Voltage	-150	V
Instantaneous Peak Grid-Cathode Voltage		
Grid negative to cathode	-400	v
Grid positive to cathode	30	v
DC Plate Current	250	mA
DC Grid Current	45	mA
Plate Dissipation		
Forced-air cooling (ML-8535)	150	W
Conduction and convection (ML-8534)	10	W†
Grid Dissipation	1.5	W
Frequency	2.5	GHz

Typical Operation, Power Amplifier

Frequency	500	MHz
Filament Voltage	6.0	V
DC Plate Voltage	900	V
DC Grid Voltage	-30	V
DC Plate Current	140	mA
DC Grid Current, approximate	40	mA
Driving Power, approximate	9	W
Useful Power Output	65	W

Typical Operation, Power Amplifier

Frequency	2.3	GHz
Filament Voltage	5.5	V
DC Plate Voltage	1400	V
DC Plate Current	250	mA
Useful Power Output	100	W
Gain	13	db

**Grid-Pulsed or Plate-Pulsed RF Oscillator
or Amplifier—Class C**

Maximum Ratings, Absolute Values

Plate Voltage		
Grid-pulsed, DC	2500	V
Plate-pulsed, peak pulse supply	3500	v
DC Grid Voltage	-150	V
Instantaneous Peak Grid-Cathode Voltage		
Grid negative to cathode	-750	v
Grid positive to cathode	250	v
Average Plate Current	16	mA
Average Grid Current	6	mA
Pulse Plate Current	5	a
Average Plate Dissipation		
Forced-air cooling (ML-8535)	60	W
Conduction and convection (ML-8534)	10	W†
Average Grid Dissipation	1.5	W
Pulse Duration	6	μs††
Duty Factor0033	††
Frequency	3	GHz

Typical Operation, Grid-Pulsed RF Amplifier

Frequency	1.1	GHz
Filament Voltage	6.3	V
Pulse Duration	3.5	μs
Duty Factor001	
DC Plate Voltage	2000	V
DC Grid Voltage	-70	V
Peak Plate Current from DC Supply	3.0	a
Peak Grid Current from Pulse Supply	1.0	a
Driving Power During Pulse, approximate	400	W
Useful Peak Power Output, approximate	2.5	kw

Pulse Modulator or Pulse Amplifier

Maximum Ratings, Absolute Values

DC Plate Voltage	2500	V
Peak Plate Voltage	3500	v
DC Grid Voltage	-150	V
Instantaneous Peak Grid-Cathode Voltage		
Grid negative to cathode	-750	v
Grid positive to cathode	110	v
DC Plate Current	150	mA
Pulse Cathode Current	7.5	a
Average Plate Dissipation		
Forced-air cooling (ML-8535)	150	W
Conduction and convection (ML-8534)	10	W†
Average Grid Dissipation	1.5	W
Pulse Duration	6	μs††
Duty Factor0033	††

†Greater plate dissipation will be possible with the ML-8534 when the tube is used with an appropriately designed heat sink.

††For applications requiring longer pulse duration or higher duty factors, consult the Machlett Engineering Department.

**CHARACTERISTIC RANGE VALUES
FOR EQUIPMENT DESIGN**

	Min.	Max.
Filament Current at 6.3 V (Note 1)	1.20	1.40
Cut-Off Bias (Note 2)	—	-30
Grid-Plate Capacitance (Note 3)	2.10	2.40
Grid-Cathode Capacitance (Note 3)	8.50	10.50
Plate-Cathode Capacitance (Note 3)	—	.065

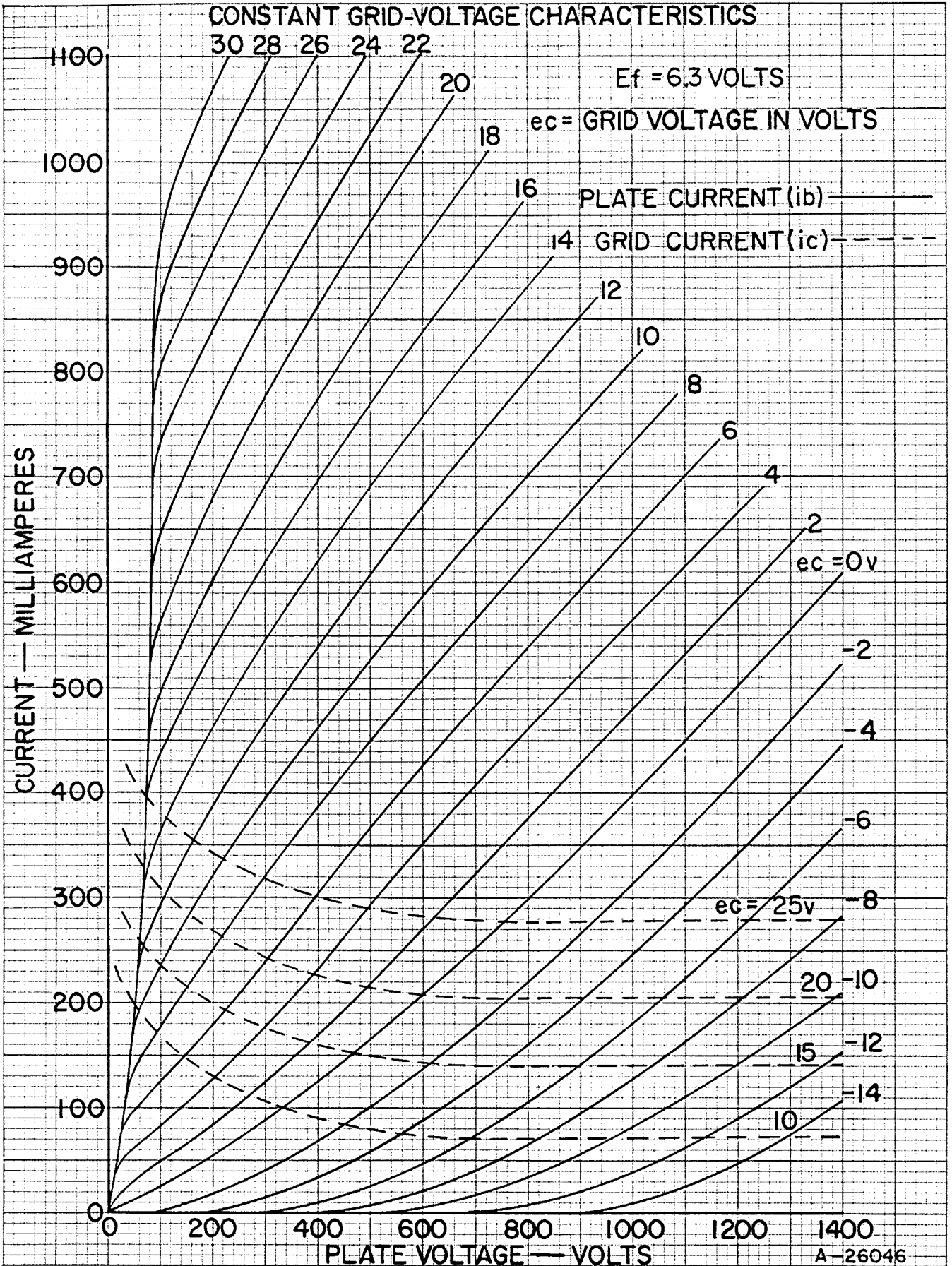
Note 1 — For reduced filament voltage see "Heater Voltage" section in *Application Notes*.

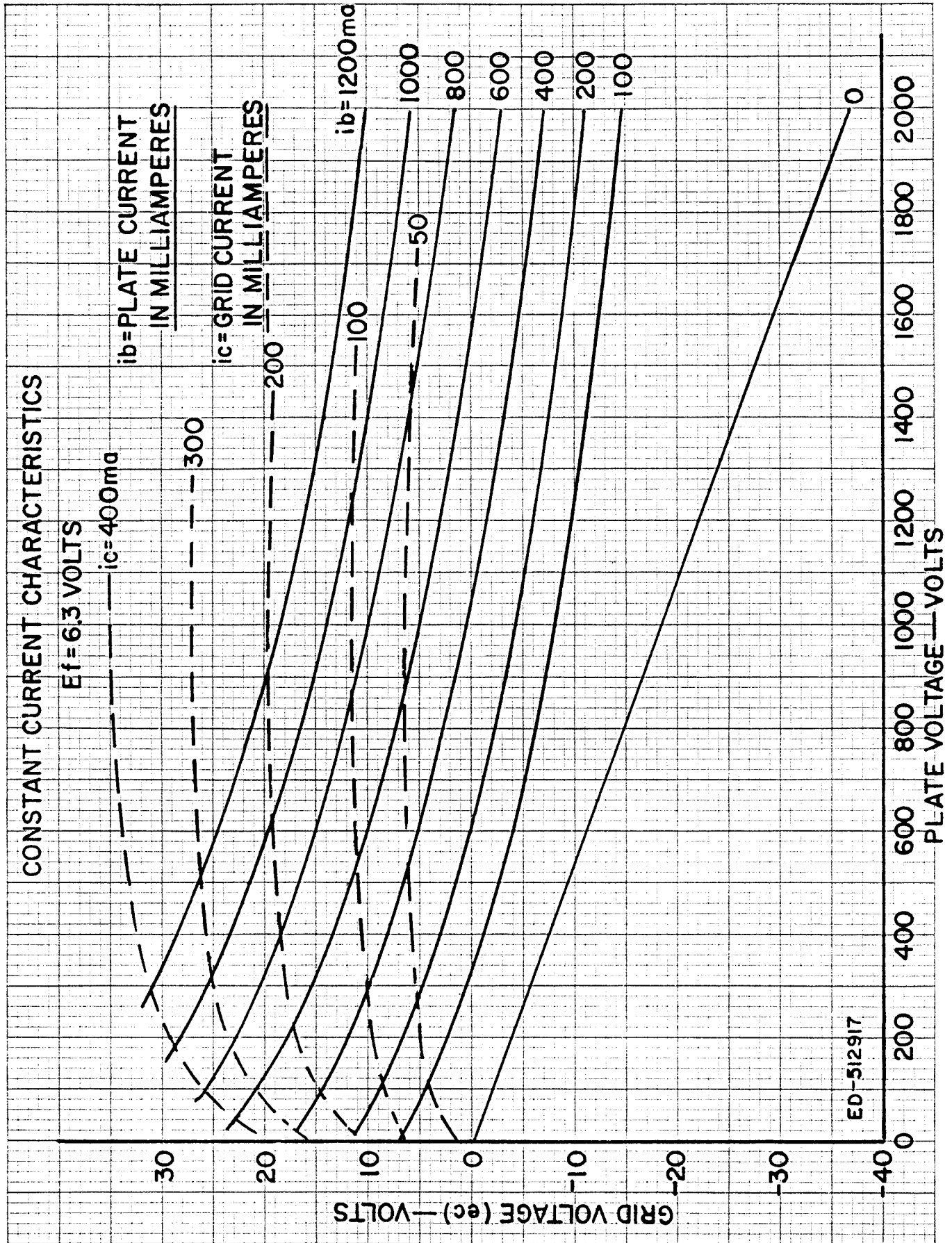
Note 2 — Measured with 1 mA plate current and a plate voltage of 1000 Vdc.

Note 3 — Capacitance values are given for a cold tube. When the filament is heated to its proper temperature, the grid-cathode capacitance will increase by approximately 1 pf due to thermal expansion of the cathode.

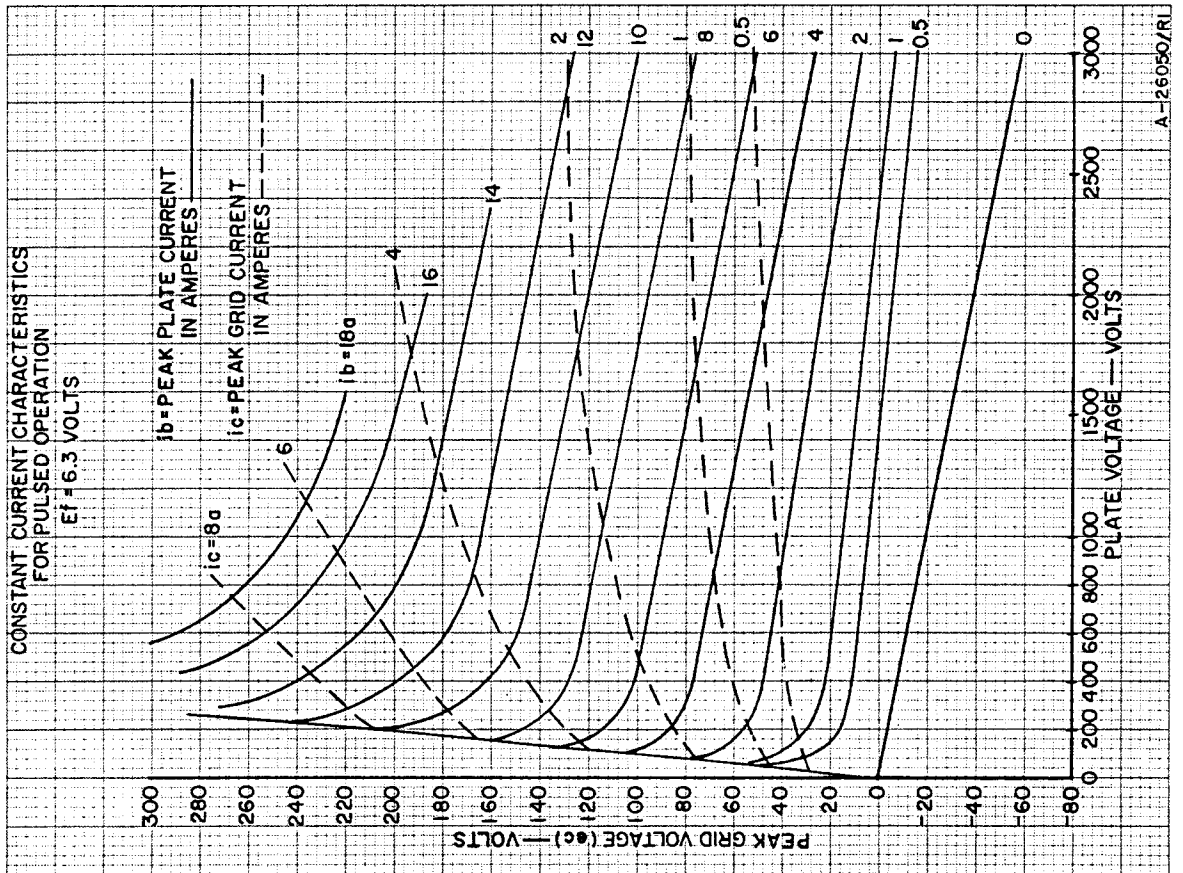
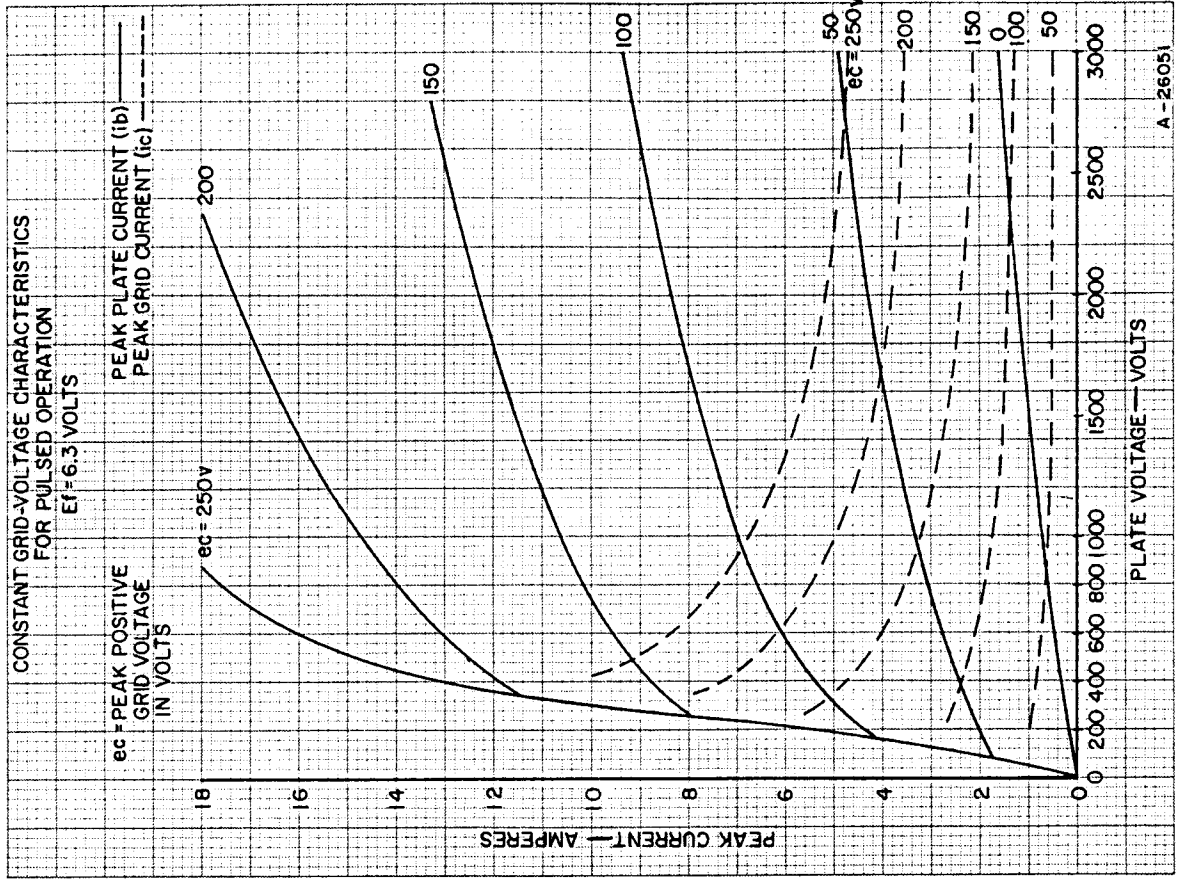
APPLICATION NOTES

Before designing equipment for use with these tubes and before installing tubes in equipment, refer to the general information given in the Machlett publication entitled *Application Notes, UHF Tubes—General*.



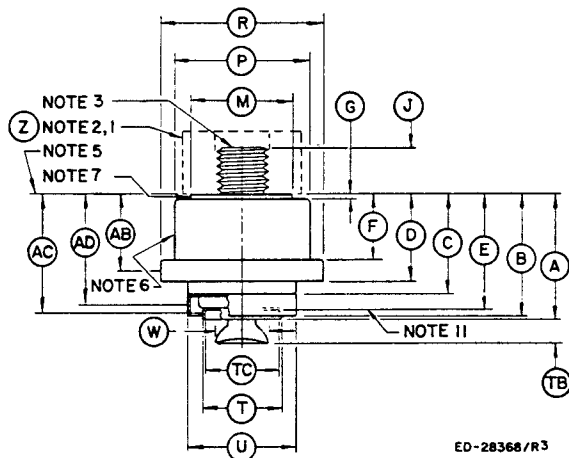
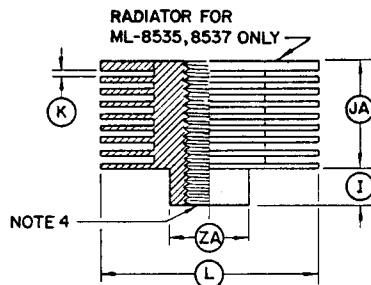


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The millimeter dimensions are derived from the original inch dimensions.

Ref	Inches			Millimeters			Notes
	Minimum	Nominal	Maximum	Minimum	Nominal	Maximum	
A	.714		.780	18.14		19.81	
AB	.437	.476	.515	11.10	12.09	13.08	1, 8
AC	.662	.682	.702	16.81	17.32	17.83	1, 10
AD	.605	.645	.685	15.37	16.38	17.40	1, 9
B	.691		.740	17.55		18.80	
C	.570		.607	14.48		15.42	
D	.520		.547	13.21		13.89	
E	.650		.705	16.51		17.91	
F	.400		.415	10.16		10.54	
G	.022		.040	.56		1.02	
I	.192		.208	4.88		5.28	
J	.240		.275	6.10		6.98	
JA	.585		.635	14.86		16.13	
K	.028		.045	.71		1.14	
L	1.235		1.265	31.37		32.13	
M	.565		.580	14.35		14.73	
P	.775		.785	19.68		19.94	
R	.935		.950	23.75		24.13	1, 8
T	.440		.460	11.18		11.68	1, 10
TB			.250			6.35	
TC	.410		.425	10.41		10.80	
U	.595		.607	15.11		15.42	1, 9
W			.313			7.95	
Z			.015			.38	1
ZA	.440		.460	11.18		11.68	



ED-28368/R3

NOTES:

1. The total indicated runout of the grid-contact surface (Note 8), the cathode-contact surface (Note 9) and the heater-contact surface (Note 10) will not exceed (Z). This measurement is made with the gage (Note 2) screwed on the anode thread (Note 3) so that the face of the gage makes full contact with the reference surface (Note 5). Runout is then measured with the gage chucked on the measurement reference axis.
2. See outline. Machlett gage No. S-L5. Details will be supplied upon request.
3. See outline. Anode, $\frac{5}{16}$ - 24 UNF-2A thread.
4. See outline. $\frac{5}{16}$ - 24 UNF-2B thread. Use $\frac{5}{16}$ -24 bolt in this hole for tube extraction.
5. See outline. Reference surface. The tube shall be stopped only by this surface when screwed in the socket.
6. See outline. Insulating envelope. Do not clamp or locate on this surface.
7. See outline. Measure anode temperature on this surface.
8. Grid-contact surface and reference dimension for eccentricity measurement, defined by dimensions (R) and (AB).
9. Cathode- or heater-contact surface and reference dimension for eccentricity measurement, defined by dimensions (U) and (AD).
10. Heater-contact surface and reference dimension for eccentricity measurement, defined by dimensions (T) and (AC). See also Note 11.
11. See outline. Alternate heater-contact surface. Heater contact can be made to the bottom of the heater terminal-cup by means of a coil spring having a maximum coil OD of .390 inch and a minimum coil ID of .320 inch, or some similar device.

RAYTHEON

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